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	component				
item	name	spec & type	component position	substitute materials	remark
<b>—</b> ,	SMT				
	JIVI I	BS-G66CP-1/3/5/6 V: 1.0 SMT complete			
			L13 D19		
			R22, R23, R25, R26, R33, R34, R36, R40, R54, R61, R77		
		resistance/stick,common,0 $\Omega$ , $\pm 5\%$ , 1/16W, 0402	R97, R103, R110, R149, R193, R235		
			R251, G R1, G R14		
			R21, R24, R122		
			R321		
			R55, R124		
			R32, R88, R89, R90, R91		
			G R4, G R5, G R6		
			R43, R185		
			R8		
		resistance/stick,common,2K $\Omega$ , $\pm$ 5%, 1/16W, 0402	R29, R30, R170		
1		resistance/stick,common,3K $\Omega$ , $\pm$ 5%, 1/16W, 0402	R171		
	stick	resistance/stick,common,15K $\Omega$ , $\pm$ 5%, 1/16W, 0402	R6, R7		
	resistance	resistance/stick,common,20K $\Omega$ , $\pm$ 1%, 1/16W, 0402	R85		
		resistance/stick,common,33K $\Omega$ , $\pm$ 5%, 1/16W, 0402	R31 G_R2		
		resistance/stick,common,62.5K $\Omega$ , $\pm$ 1%, 1/16W, 0402	R86		
		resistance/stick,common,91K $\Omega$ , $\pm$ 5%, 1/16W, 0402	R37		
		resistance/stick,common,100K $\Omega$ , $\pm$ 5%, 1/16W, 0402	R1, R2, R4, R12, R13, R14, R15, R16, R28, R108, R111,		
			R121, R182 R183 R217, R285		
			R44, R234		
			R76		
			R41, R179		
			R42		
		resistance/stick,common,10K $\Omega$ , $\pm 5\%$ , 1/8W, 0402	R11, R17, R18, R20, R38, R45, R46, R48, R50, R51, R52, R53		
			R60, R65, R92, R94, R123, R184, R190, R200, R220, R221, R22 2, R223, R232, R246		
	stick rank	resistance/stick rank resistance 8P4R 100 +5%	RA10 RA11 RA12 RA13 RA14 RA15		
		resistance/stick rank resistance 8PAR 220 +5%	RA7 RA8 RA9 RA16 RA17 RA18		

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vame: E	32-600CP AS	sy materials list		date: 2008. 7. 08	
item	component name	spec & type	component position	substitute materials	remark
		capaci tance/stick, figuline, 4.7nF, 10V, X7R, $\pm$ 10%, 0402	C114 C115 C116 C117		
			C72, C218, G_C7, G_C9, G_C11, G_C13, G_C14, G_C16, G_C17, G_C18, G_C25, G_C26		
		capaci tance/stick, figuline, 100nF, 10V, X7R, $\pm$ 10%, 0402	C4, C6, C7, C9, C12, C13, C14, C15, C16, C17, C18, C19, C20, C 21, C22, C23, C24, C25, C26, C27, C28, C29, C30, C31, C35, C36, C37, C38, C39, C41, C42, C43, C44, C 45, C46, C47, C48, C49, C50, C51, C58, C65, C66, C69, C70, C73, C78, C79, C82, C108, C109, C138 C146, C159, C164, C210, C211, C214, C222, C229, C252, C		
		capacitance/stick, figuline, 1.8pF, 50V, COG, ±0.25pF, 0402			
		consolitance (atialy figuration 10mE FOV COC.)	G_C8		
			C2 C33		
		capacitance/stick, figuline, 20pF, 10V, COG, $\pm$ 5%, 0402	C1, C32		
2	capaci tance		G_C2, G_C3, G_C10		
		capacitance/stick, figuline, 33pF, 10V, X7R, ±5%, 0402	C129 C130 C131		
		capacitance/stick, figuline, 100pF, 50V, X7R, ±5%, 0402	C3, C5, C8, C10, C11, C254, C256 G_C1, G_C22		
		capaci tance/stick, figuline, 220pF, 10V, X7R, $\pm$ 10%, 0402	G_C12		
		capacitance/stick, figuline, 1uF, 10V, X7R, $\pm$ 10%, 0603	C161 C163 C169 C262 C263 C264 C265 C266 C267		
		capacitance/stick, figuline, 2.2uF, 10V, X5R, $\pm$ 10%, 0603	C52 G_C23, G_C24		
			C34, C40, C86, C110, C111, C165, C167, C168, C215, C 217, C219		
		capaci tance/stick, fi gul i ne, 4. 7uF, 10V, X7R, +80% - 20%, 0805	C57 C162 C170 C172 C173 C195		
		capacitance/stick, tantalum capacitance, 2. 2uF, 35V, $\pm$ 10%, 3528	C251		
2	stick capacitance	capacitance/stick, tantalum capacitance, 10uF, 10V, $\pm$ 10%, 3216	C54, C74, C77, C80		
		10%, 3216	C166, C193 C196, C232		
		110% 2630	C158		
		capaci tance/stick, tantalum capaci tance, 100uF, 10V, $\pm$ 10%, 3528			
3	stick		G_L3		
			G_L1, G_L2		
			L17, L19		
		inductance/power, WBD3D16#220N-R, 22uH, ±30%, 404mA	L12		
Л	stick hoad	magnetism bead/stick,BLM21BB471SN, 200mA, $\pm$ 25%,0805	FB5 FB6		

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item	component name	spec & type	component position	substitute materials	remark
4	Strck beau	magnetism bead/stick,BLM18BA220SN, 500mA, ±25%,0603	L15, L16, L29, L30, L31, FB3 FB4 FB10, G_BD1, G_BD2		
5	stick crystals	crystal shake /resonance, 12.0000MHz, Crystal, $\pm$ 20ppm, stick	Y1	crystal shake /resonance,12.0000MHz,Crystal,± 20ppm,5*3.2 stick	
		crystal shake /resonance, 32.768KHz, Crystal, $\pm$ 20PPM.12.5pF.stick EPSON MC-146 crystal shake/filter, 1575.42 MHz, 2.5*2.0, $\pm$ 1MHz, TST TA0295A	Y2 FL1		
		crystal shake /resonance, 16.367667MHz, OSCI, ± 0.5PPM, 3.2*2.5, KDS, stick	G_Y1		

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item	component name	spec & type	component position	substitute materials	remark
		diode/stick,SD12,SOD-323N	D17		
6	stick	di ode/stick, SS14, DO-214AC	D3		
	Stick	diode/stick,RB161VA-20TR	D21		
	drode/audron	steady voltage, MMBZ5232B, SOT-23 FAIRCHILD	D11		
		audion/stick, NPN, MMBT3904, SOT-23	03 05 06 012,013		
7		mosfet/stick, ME2302, SOT-23	09		
		mosfet/stick, ME2301, SOT-23	Q10 Q14 Q18 Q20		
		IC/stick, Atlas-III Processor, AT640, TFBGA- 332LD, 372MHZ brede	U1		
		IC/stick, ALC5611D-GR, Audio, QFN48, Realtek	U6		
		IC/stick, K9F1208U0M-PCB0, TS0P48, Samsung	NAND1	IC/stick, HY27US08121A, TS0P48, HYNIX	
1		IC/stick, IT6213C33, SOT-23-5, brede	G U4		
		IC/stick, SN74LVC1G3157, SC706 brede	U5 U7		
		IC/stick, SE4110L, QFN24 4x4, brede	G_U1		
8	STICK IC	IC/stick,K4S561632H-UC75,SDRAM, TSOP54,brede	U3, U4	IC/stick, W9825G6DH-75, SDRAM, TSOP54, brede	
		IC/stick, BS4024 SO-8, brede or tube	U12		
		IC/stick,IT92101, TQFN44-24,brede	U16		
		IC/stick,IT6213B12, SOT-23-3,brede	U17		
		IC/stick,IT6213A33, SOT-23-3,brede	U20		
		IC/stick, IT6213C13, SOT-23-5, brede	U19		
		socket,Wafer,2 pin,1.0mm	LS1		
		socket,Wafer,4PIN 1.00mm	BAT1		
9	stick jack	socket/USB socket,MINI USB 5P	J2		
,	-	socket, FPC, 54 PIN, O.5mm, for LCD	P3		
		socket, FPC, 4 PIN, 1.0mm, for touch panel	CN10		
		socket/SD trough, SDC009-A0-2274	P2		
10	stick switch	switch/dial SK-004	SW4		
		switch/button,IT1205SMD,stick	SW2 S2		
11		shi ne/LED, xy-0805R&G100-50H, RED&GREEN	LED1		
		G56C/RF shielding, tin			
12		G66C-3/load shielding, tin			
		G66C-3/CPU shielding, tin			
12	PCB	PCB/main board, BS-G66CP V1.0 8layers, glass fibre, 74mmX68mmX1.0mm			
=	DIP				
1	shi el di ng	G53C/RF shielding, tin			
2		G66C-3/load shielding, tin			
3		G66C-3/CPU shielding,tin			
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